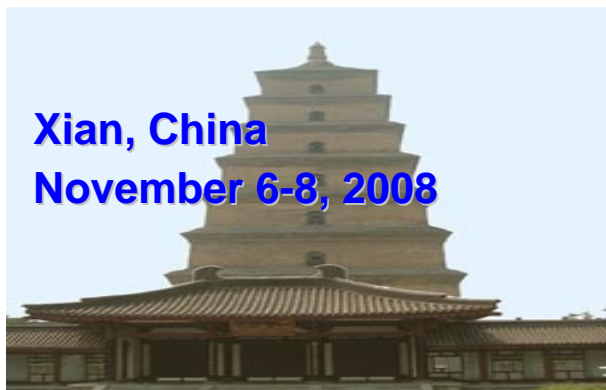


3rd International Symposium on Integrated Molecular/Materials Engineering (ISIMME-3)



Xian, China
November 6-8, 2008

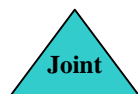
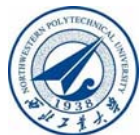
Prospective authors are invited to submit an abstract to Prof. Qiuyu Zhang. Your abstract should contain a title, aim of study, brief description of methodology, salient results, conclusion and significance of the paper. Please use font type "time new roman", point size 12 when submitting your abstract.

Abstracts should be sent by e-mail

(qyzhang@nwpu.edu.cn or zhangjunping@nwpu.edu.cn)

IMPORTANT DEADLINES:

Deadline for Abstracts: 31 August 2008



REGISTRATION

Registration fee:

40,000 JPY for participant

20,000 Yen for student

Registration fees for delegates are entitled to :

1. Admission to All Technical Sessions
2. Banquet on Nov. 6-8
3. Symposium Materials

THE PROGRAM

Plenary lectures

Keynote lectures

Contributed oral presentations

Poster presentation with 5 min talk

GENERAL INFORMATION

Data: November 6-8, 2008

Venue: Northwestern Polytechnical University (NWPU) <http://www.nwpu.edu.cn>

Language: The official language is English



Chairpersons:

Chair: Prof. Qiuyu Zhang (NWPU, China)

Co-Chair: Prof. Tomokazu Iyoda (TIT, Japan)

Prof. Wanti Yang (BUCT, China)

Organizing Committee

Chinese side: Prof. Bingbo Wei (NWPU)

Prof. Hejun Li (NWPU)

Prof. Xiaodong Fan (NWPU)

Prof. Yu Fang (SNNU)

Prof. Feng Wang (BUCT)

Prof. Liqun Zhang (BUCT)

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Prof. Xinli Jing (XJTU)

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Prof. Shigeru Watanabe (Kochi Univ.)

Prof. Hiroko Yamada (Ehime Univ.)

As. Prof. Motonori Komura (TIT)

Korean side: Prof. Sang Ouk Kim (KAIST)

ABOUT SYMPOSIUM

Materials science has made remarkable progress and furthermore is growing in broad fields. It should be realized as one of the most interdisciplinary and borderless science, beyond conventional categories such as organic and inorganic materials, metals and semiconductors, and macro-molecules and supra-molecules, hybrid nanomaterials, metamaterials, as well as to provide new circumstances for well-motivated young scientists to develop new sciences. Especially, multilateral integration will be significant in the coming materials science including various kinds of materials, syntheses and processing, methodology, processing, and so forth, as is realized in Chinese traditional craftworks. Not only interdisciplinary fields but also exchanges of researchers should be crucial to drive such new movement. After the successful kick-off meetings in 2006 and 2007, the organizing committee are very happy to organize the third symposium along our strong motivation to promote long-term continuous exchange programs involving collaborative research, regular international symposia, mutual visits, exchange of students and scientists, and so on.